

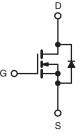


## **D** Series Power MOSFET

PRODUCT SUMMARY					
$V_{DS}$ (V) at $T_J$ max.	450				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 1.0				
Q <sub>g</sub> max. (nC)	18				
Q <sub>gs</sub> (nC)	3				
Q <sub>gd</sub> (nC)	4				
Configuration	Single				

### **TO-220AB**





N-Channel MOSFET

#### **FEATURES**

- Optimal Design
  - Low Area Specific On-Resistance
  - Low Input Capacitance (Ciss)
  - Reduced Capacitive Switching Losses
  - High Body Diode Ruggedness
  - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
  - Low Cost
  - Simple Gate Drive Circuitry
  - Low Figure-of-Merit (FOM): Ron x Qa
  - Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### Note

Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

#### **APPLICATIONS**

- Consumer Electronics
  - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies - SMPS
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SiHP6N40D-E3
Lead (Pb)-free and Halogen-free	SiHP6N40D-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	400		
Gate-Source Voltage			M	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)			V <sub>GS</sub>	30		
Continuous Drain Current (T. 150 °C)	$T_{\rm C} = 25 ^{\circ}{\rm C}$		6			
Continuous Drain Current ( $T_J = 150 \ ^\circ C$ )	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	l <sub>D</sub>	4	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	13	1	
Linear Derating Factor				0.8	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	104	mJ	
Maximum Power Dissipation			PD	104	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		dV/dt	24		
Reverse Diode dV/dt <sup>d</sup>		αν/αι	0.48	V/ns		
Soldering Recommendations (Peak Temperature)	for 10	S		300 <sup>c</sup>	°C	

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 2.3 mH,  $R_q = 25 \Omega$ ,  $I_{AS} = 9.5$  A.

1.6 mm from case. C.

d.  $I_{SD} \leq I_D$ , starting  $T_J = 25 \ ^{\circ}C$ .

S12-0687-Rev. A, 02-Apr-12



1 For technical questions, contact: hvm@vishay.com

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PARAMETER Maximum Junction-to-Ambient Maximum Junction-to-Case (Drain)	SYMBOL	TYP.		MAY	1			
				MAX.		UNIT		
Maximum Junction-to-Case (Drain)	R <sub>thJA</sub>	-		62				
	R <sub>thJC</sub>	- 1.2			°C/W			
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	1		IONS	MIN.	TYP.	MAX.	UNIT
Static								<b>I</b>
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 μA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			I <sub>D</sub> = 250 μA	-	0.53	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		V <sub>GS</sub> , I <sub>D</sub> =		3	-	5	V
Gate-Source Leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30$		-	-	± 100	nA
, i i i i i i i i i i i i i i i i i i i	466		400 V, V <sub>0</sub>		-	-	1	- μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-		V, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		$I_D = 3 A$	-	0.85	1.0	Ω
Forward Transconductance	g <sub>fs</sub>		= 50 V, I <sub>D</sub>		-	1.7	-	S
Dynamic	010						L	I
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	311	-	-	
Output Capacitance	C <sub>oss</sub>			-	38	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	7	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 0 V to 320 V		-	44	-	pF	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	54	-	1	
Total Gate Charge	Qa	V <sub>GS</sub> = 10 V I <sub>D</sub> = 3 A, V <sub>DS</sub> = 320 V		-	9	18	nC	
Gate-Source Charge	Q <sub>gs</sub>			-	3	-		
Gate-Drain Charge	Q <sub>gd</sub>			-	4	-		
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{DD} = 400 \text{ V}, \text{ I}_D = 3 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$		-	12	24		
Rise Time	t <sub>r</sub>			-	11	22	-	
Turn-Off Delay Time	t <sub>d(off)</sub>			-	14	28	- ns	
Fall Time	t <sub>f</sub>			-	8	16		
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	1.9	-	Ω	
Drain-Source Body Diode Characteristic			ý - I					
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	_	24	A	
Diode Forward Voltage	V <sub>SD</sub>	$T_J = 25 \text{ °C}, I_S = 3 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>				-	236	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 2$	5 °C, I <sub>F</sub> =	$I_{\rm S} = 3  {\rm A},$	-	1.1	-	μC
Reverse Recovery Current		dl/dt = 100 A/µs, V <sub>R</sub> = 20 V		-	9	-	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

Document Number: 91498



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

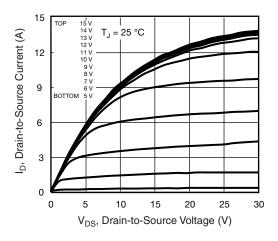


Fig. 1 - Typical Output Characteristics

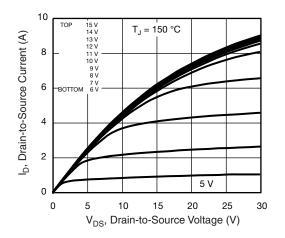


Fig. 2 - Typical Output Characteristics

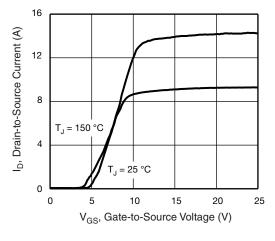


Fig. 3 - Typical Transfer Characteristics

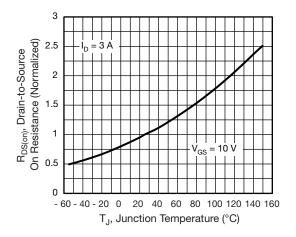


Fig. 4 - Normalized On-Resistance vs. Temperature

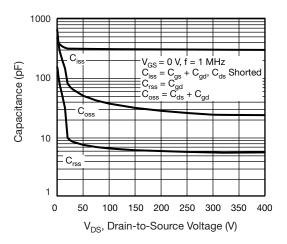
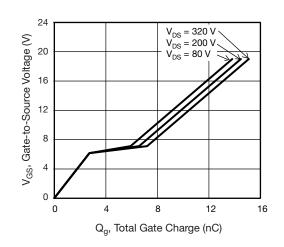


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





S12-0687-Rev. A, 02-Apr-12

3

Document Number: 91498

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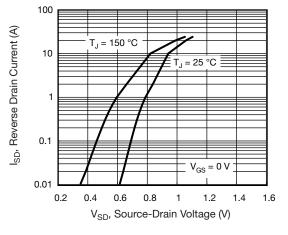


Fig. 7 - Typical Source-Drain Diode Forward Voltage

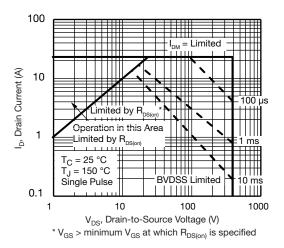


Fig. 8 - Maximum Safe Operating Area

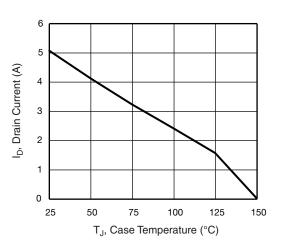


Fig. 9 - Maximum Drain Current vs. Case Temperature

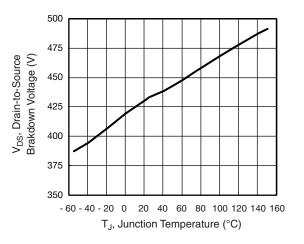
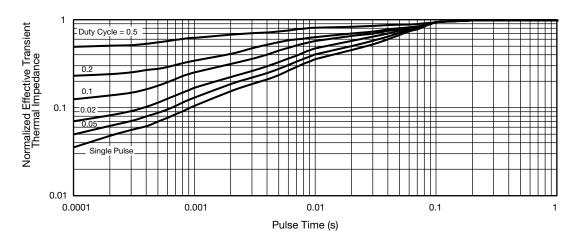
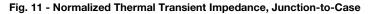


Fig. 10 - Temperature vs. Drain-to-Source Voltage





S12-0687-Rev. A, 02-Apr-12

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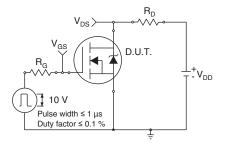


Fig. 12 - Switching Time Test Circuit



Fig. 13 - Switching Time Waveforms

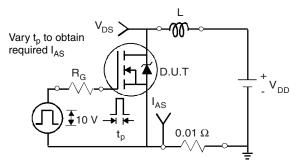


Fig. 14 - Unclamped Inductive Test Circuit

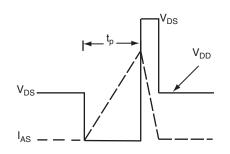


Fig. 15 - Unclamped Inductive Waveforms

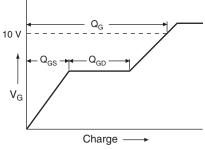


Fig. 16 - Basic Gate Charge Waveform

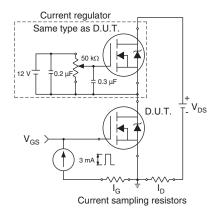


Fig. 17 - Gate Charge Test Circuit

5

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#### Peak Diode Recovery dV/dt Test Circuit

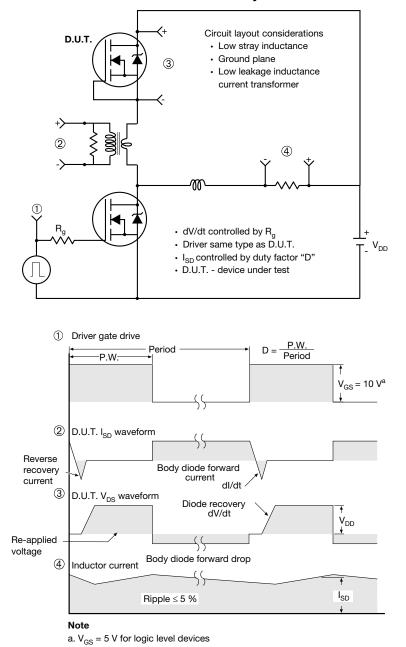


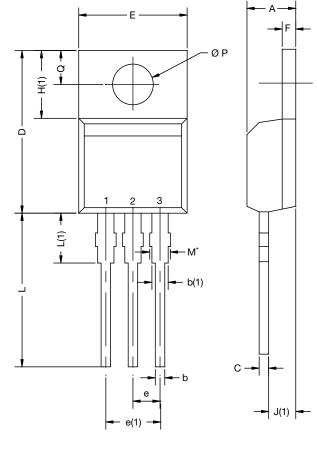
Fig. 18 - For N-Channel

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TO-220-1

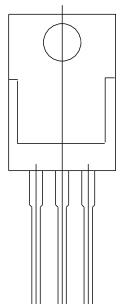


	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.14	4.70	0.163	0.185	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.73	0.045	0.068	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	0.43	1.40	0.017	0.055	
H(1)	6.10	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.59	3.00	0.102	0.118	
ECN: X15- DWG: 603 <sup>-</sup>	0003-Rev. A, I	19-Jan-15			

Notes

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

- Outline conforms to  $\mathsf{JEDEC}^{\circledast}$  outline TO-220AB with exception of dimension F



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